

Silicon Diffused Power Transistor

BU1706A

GENERAL DESCRIPTION

Enhanced performance, new generation, high-voltage, high-speed switching npn transistor in a plastic envelope intended for use in high frequency electronic lighting ballast applications.

QUICK REFERENCE DATA

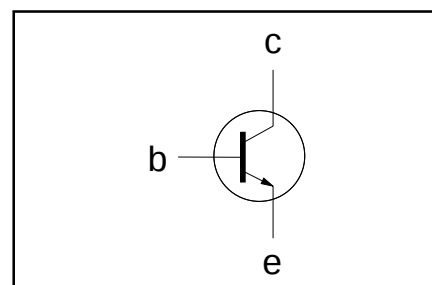
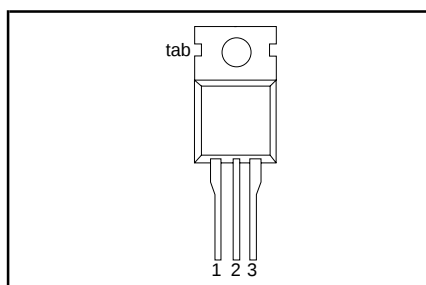
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1750	V
V_{CEO}	Collector-emitter voltage (open base)		-	850	V
I_C	Collector current (DC)		-	5	A
I_{CM}	Collector current peak value		-	8	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25\text{ °C}$	-	100	W
V_{CESat}	Collector-emitter saturation voltage	$I_C = 1.5\text{ A}; I_B = 0.3\text{ A}$	-	1.0	V
I_{Csat}	Collector saturation current		1.5	-	A
t_f	Fall time	$I_{CM} = 1.5\text{ A}; I_{B(on)} = 0.3\text{ A}$	0.25	0.6	μs

PINNING - TO220AB

PIN CONFIGURATION

SYMBOL

PIN	DESCRIPTION
1	base
2	collector
3	emitter
tab	collector



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1750	V
V_{CEO}	Collector-emitter voltage (open base)		-	850	V
I_C	Collector current (DC)		-	5	A
I_{CM}	Collector current peak value		-	8	A
I_B	Base current (DC)		-	3	A
I_{BM}	Base current peak value		-	5	A
$-I_{B(AV)}$	Reverse base current	average over any 20ms period	-	100	mA
$-I_{BM}$	Reverse base current peak value		-	4	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25\text{ °C}$	-	100	W
T_{stg}	Storage temperature		-65	150	$^{\circ}\text{C}$
T_j	Junction temperature		-	150	$^{\circ}\text{C}$

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Junction to mounting base		-	1.25	K/W
$R_{th\ j-a}$	Junction to ambient	in free air	60	-	K/W

Silicon Diffused Power Transistor

BU1706A

STATIC CHARACTERISTICS

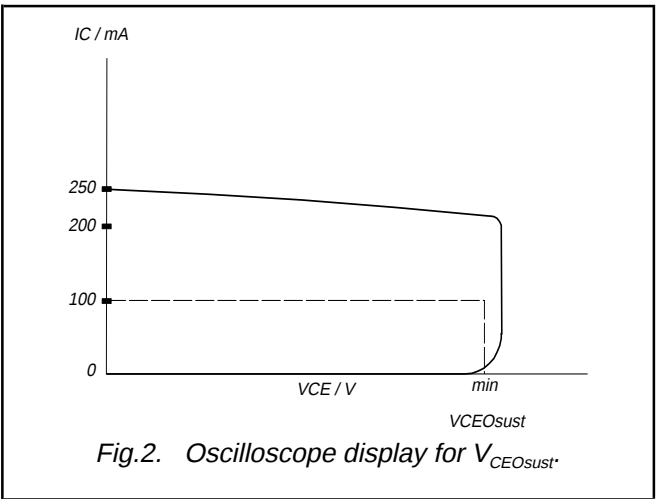
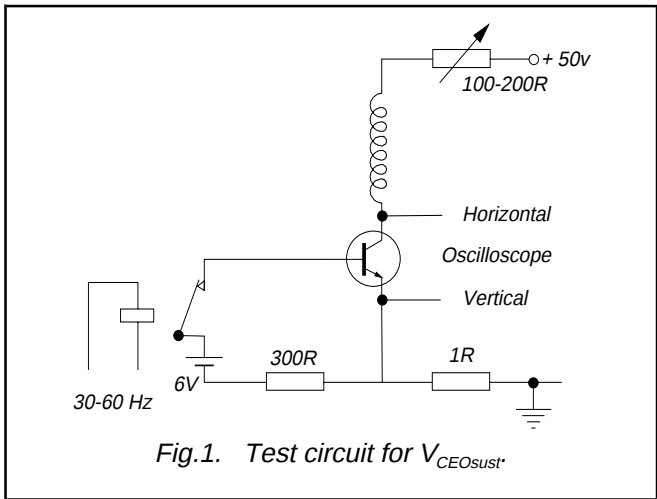
T_{mb} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CES}	Collector cut-off current ¹	V _{BE} = 0 V; V _{CE} = V _{CESMmax}	-	-	1.0	mA
I _{CES}		V _{BE} = 0 V; V _{CE} = 1500 V	-	-	20	μA
I _{CES}		V _{BE} = 0 V; V _{CE} = V _{CESMmax} ; T _j = 125 °C	-	-	2.0	mA
I _{EBO}	Emitter cut-off current	V _{EB} = 12 V; I _C = 0 A	-	-	1	mA
V _{CEOsust}	Collector-emitter sustaining voltage	I _B = 0 A; I _C = 100 mA; L = 25 mH	750	-	-	V
V _{CEsat}	Collector-emitter saturation voltage	I _C = 1.5 A; I _B = 0.3 A	-	-	1.0	V
V _{BEsat}	Base-emitter saturation voltage	I _C = 1.5 A; I _B = 0.3 A	-	-	1.3	V
h _{FE}	DC current gain	I _C = 5 mA; V _{CE} = 10 V	8	-	-	
h _{FE}		I _C = 400 mA; V _{CE} = 3 V	12	18	35	
h _{FE}		I _C = 1.5 A; V _{CE} = 1 V	5	7	-	

DYNAMIC CHARACTERISTICS

T_{mb} = 25 °C unless otherwise specified

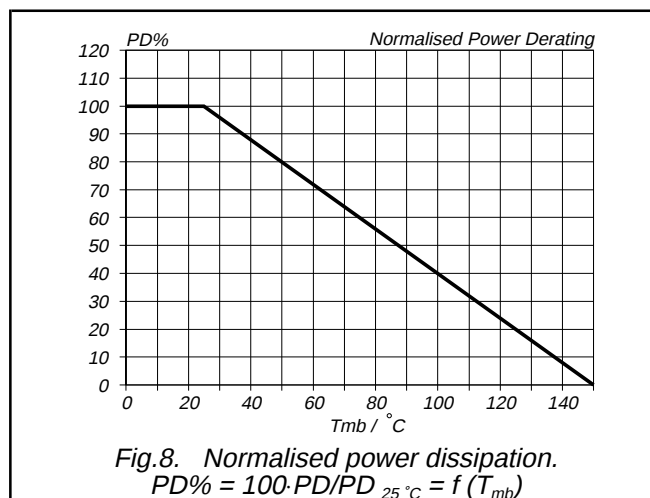
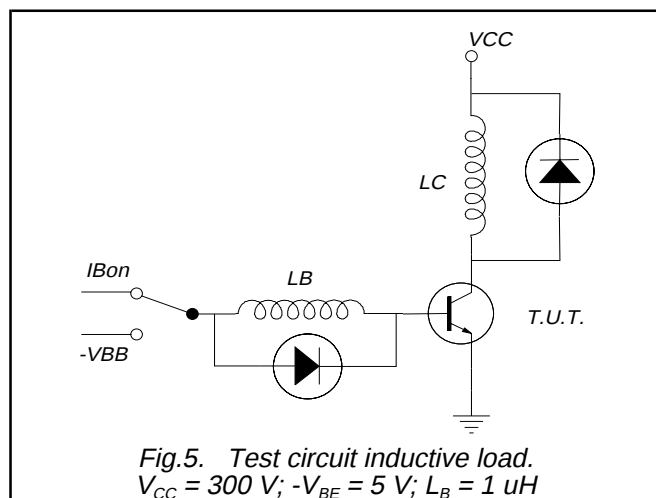
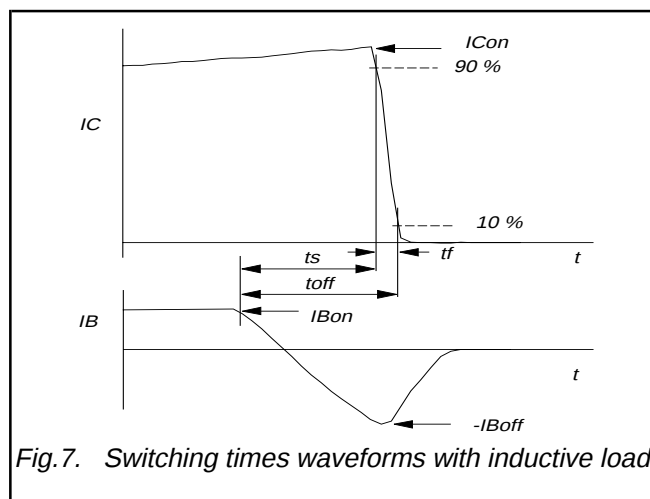
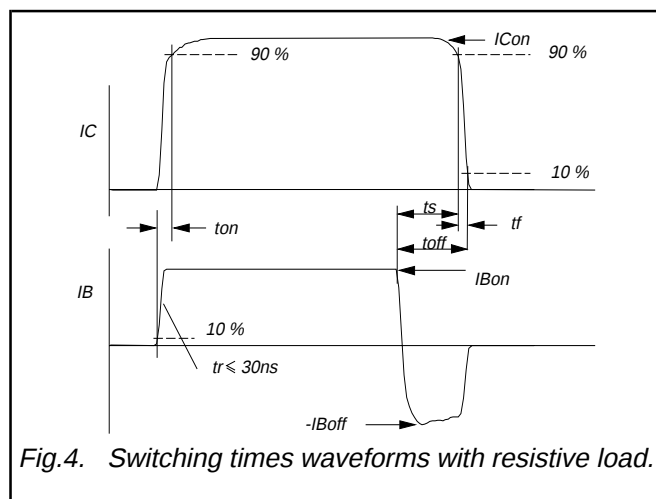
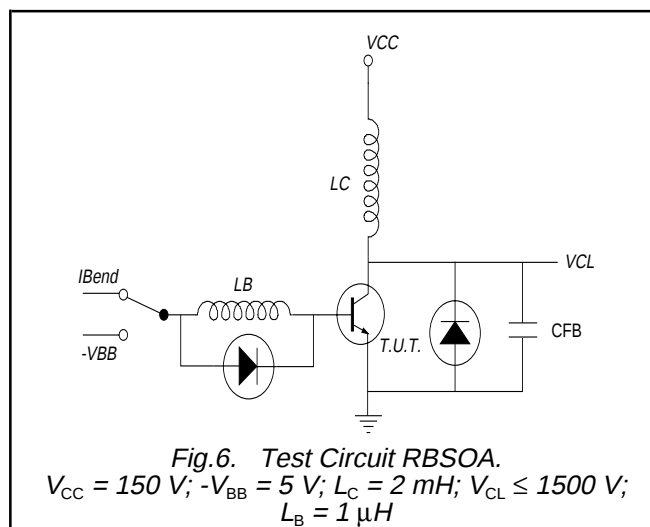
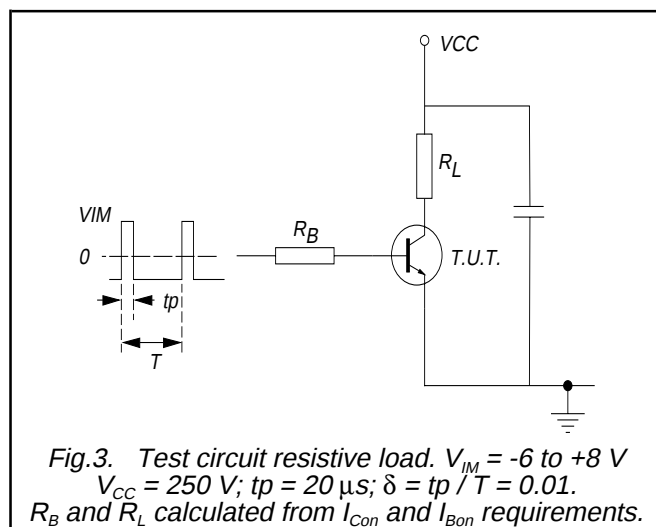
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
t _{on}	Switching times (resistive load)	I _{Con} = 1.5 A; I _{Bon} = -I _{Boff} = 0.3 A	1.1	1.5	μs
t _s	Turn-on time		5	6.5	μs
t _f	Turn-off storage time		0.75	1.0	μs
t _s	Switching times (inductive load)	I _{Con} = 1.5 A; I _{Bon} = 0.3 A; L _B = 1 μH; -V _{BB} = 5 V	2.0	3.0	μs
t _f	Turn-off storage time		0.25	0.6	μs
t _s	Switching times (inductive load)	I _{Con} = 1.5 A; I _{Bon} = 0.3 A; L _B = 1 μH; -V _{BB} = 5 V; T _j = 100 °C	2.2	3.3	μs
t _f	Turn-off storage time		0.2	0.7	μs



¹ Measured with half sine-wave voltage (curve tracer).

Silicon Diffused Power Transistor

BU1706A



Silicon Diffused Power Transistor

BU1706A

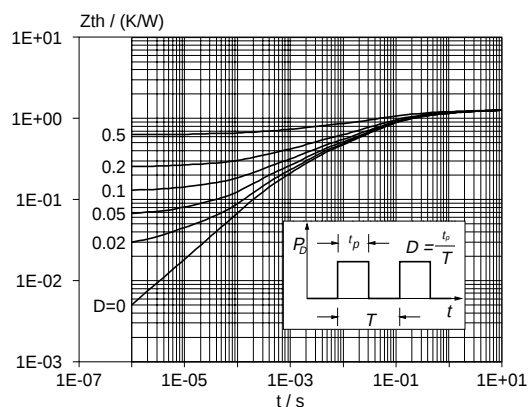


Fig.9. Transient thermal impedance.
 $Z_{th\ j-mb} = f(t)$; parameter $D = t_p/T$

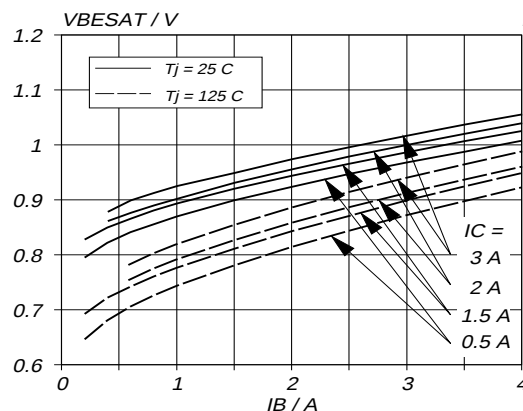


Fig.12. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_B)$; parameter I_C

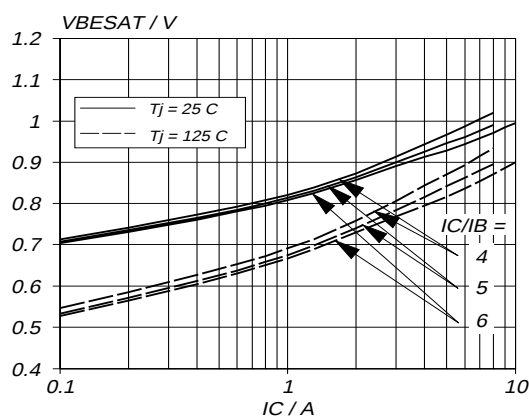


Fig.10. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_C)$; parameter I_C/I_B

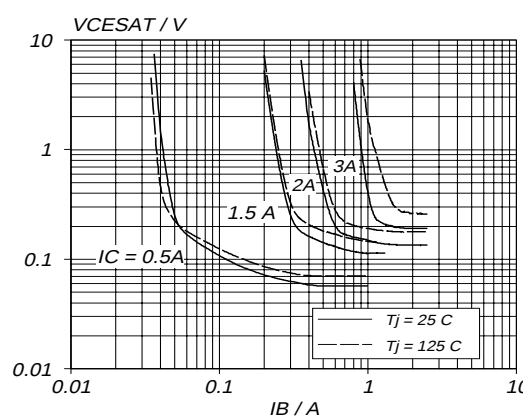


Fig.13. Typical collector-emitter saturation voltage.
 $V_{CESat} = f(I_B)$; parameter I_C

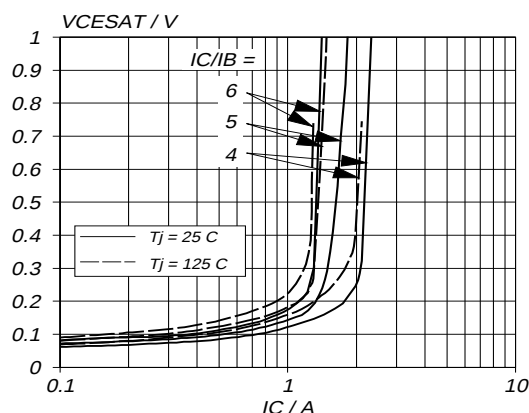


Fig.11. Typical collector-emitter saturation voltage.
 $V_{CESat} = f(I_C)$; parameter I_C/I_B

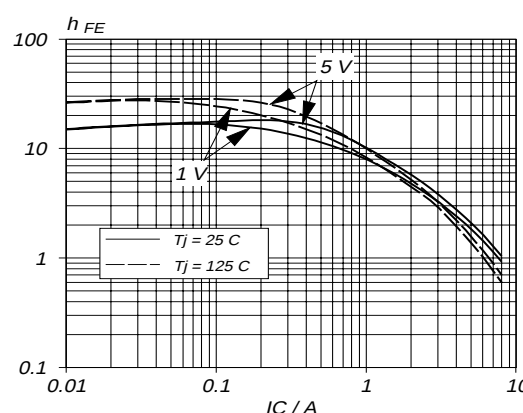
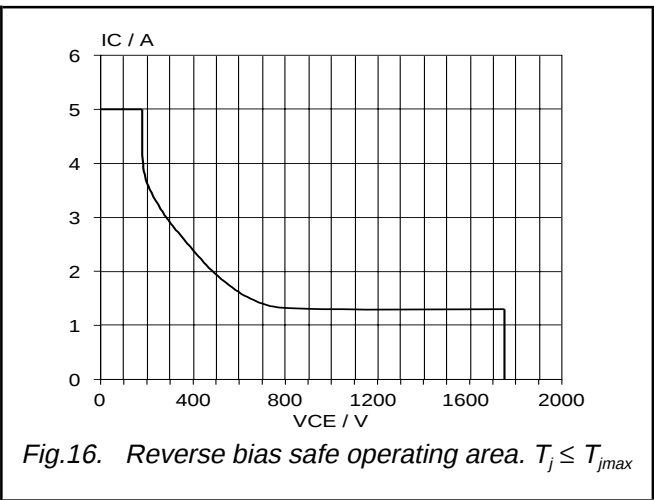
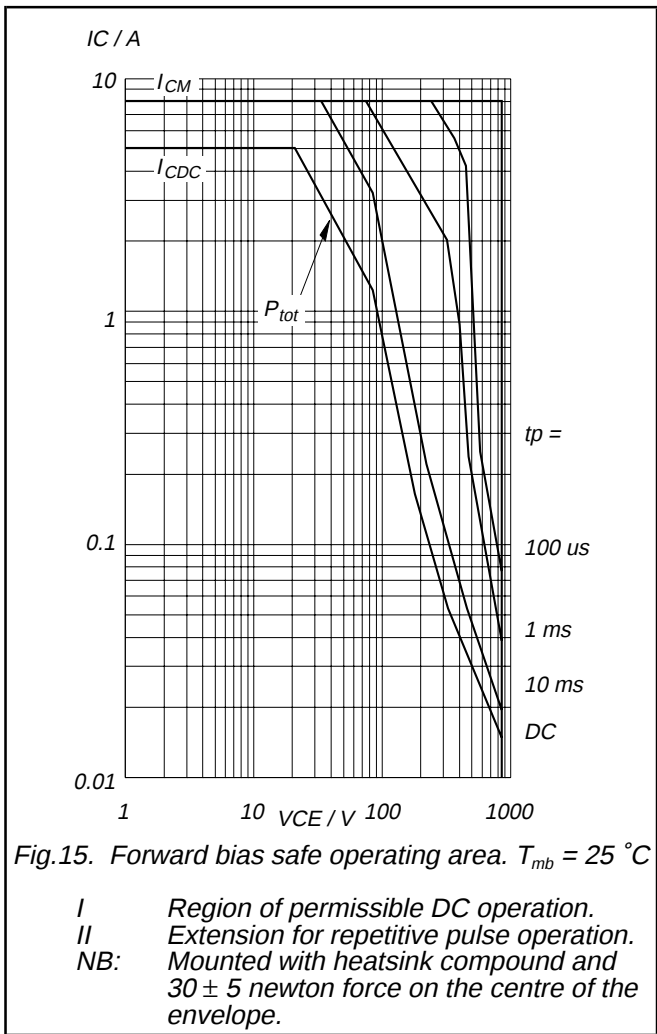


Fig.14. Typical DC current gain.
 $h_{FE} = f(I_C)$; parameter V_{CE}

Silicon Diffused Power Transistor

BU1706A



Silicon Diffused Power Transistor

BU1706A

MECHANICAL DATA

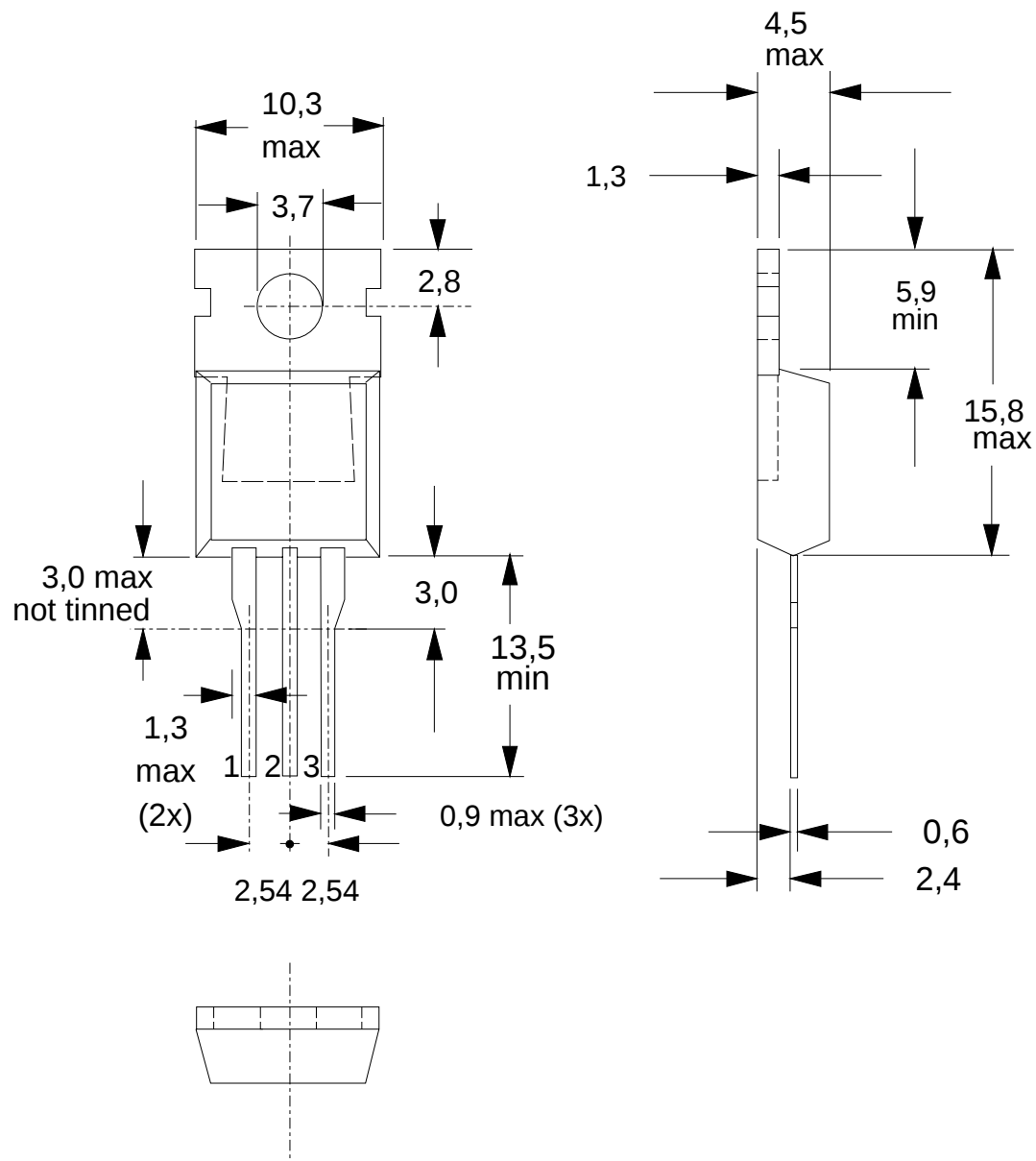
*Dimensions in mm**Net Mass: 2 g*

Fig.17. TO220AB; pin 2 connected to mounting base.

Notes

1. Refer to mounting instructions for TO220 envelopes.
2. Epoxy meets UL94 V0 at 1/8".

Silicon Diffused Power Transistor

BU1706A

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
© Philips Electronics N.V. 1997	
All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.	
The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.